

Product data sheet

1. General description

Ultrafast power diode in a 2-lead TO247-2L plastic package.

2. Features and benefits

- Fast switching
- Very low on-state loss
- Low leakage current
- Low thermal resistance

3. Applications

- Active PFC in air conditioner
- S.M.P.S Power Factor Correction (PFC)
- Half-bridge / full-bridge switched-mode power supplies

4. Quick reference data

Symbol	Parameter	Conditions		Va	lues		Unit
Absolute	maximum rating	· · · · · · · · · · · · · · · · · · ·					
V_{RRM}	repetitive peak reverse voltage		600			V	
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 129 °C; Fig. 1; Fig. 2; Fig. 3	30			A	
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 µs; T _{mb} ≤ 129 °C; square-wave pulse	60			А	
I _{FSM}	non-repetitive peak forward current	$t_{\rm p}$ = 10 ms; $T_{j(\text{init})}$ = 25 °C; sine-wave pulse; <u>Fig. 4</u>	290			А	
		$t_{\rm p}$ = 8.3 ms; $T_{j(\text{init})}$ = 25 °C; sine-wave pulse		330			А
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	aracteristics						
V _F	forward voltage	I _F = 30 A; T _j = 25 °C; <u>Fig. 6</u>		-	1.18	1.55	V
		I _F = 30 A; T _j = 150 °C; <u>Fig. 6</u>		-	0.98	-	V
Dynamic	characteristics						
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; \text{ d}I_F/\text{d}t = 50 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$		-	42	75	ns
		$I_F = 30 \text{ A}; V_R = 400 \text{ V}; \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$		-	65	-	ns
		I _F = 30 A; V _R = 400 V; dI _F /dt = 200 A/μs; T _i = 125 °C; <u>Fig. 7</u>		-	101	-	ns

5. Pinning information

	Pinning infor			
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode		К-К-А
2	А	anode		001aaa020
mb	mb	mounting base; connected to cathod	Г Т Т Т О247-2L	

6. Ordering information

Table 3. Ordering information						
Type number	Package name	Orderable part number	Packing method	Small packing quantity	•	Package issue date
BYV30W-600PT2	TO247-2L	BYV30W-600PT2Q	Tube	30	TO247L-2L	10-Nov-2020

7. Marking

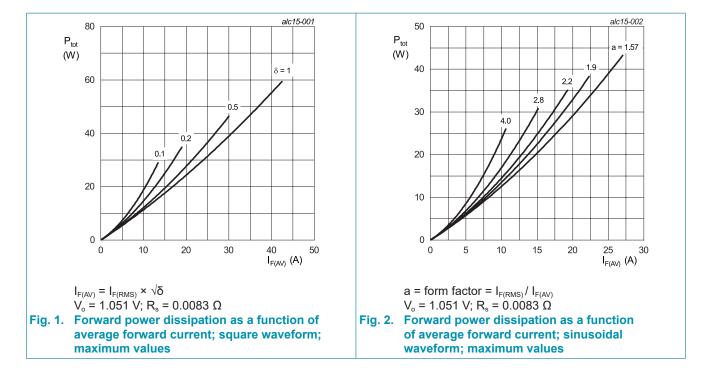
Table 4. Marking codes				
Type number	Marking codes			
BYV30W-600PT2	BYV30W 600PT2			

8. Limiting values

Table 5. Limiting values

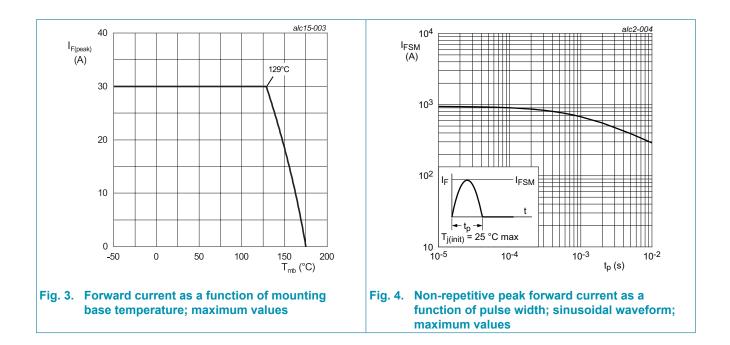
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		600	V
V_{RWM}	crest working reverse voltage		600	V
V _R	reverse voltage	DC	600	V
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 129 °C; Fig. 1; Fig. 2; Fig. 3	30	A
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 μs; T _{mb} ≤ 129 °C; square-wave pulse	60	A
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	290	A
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	330	A
T _{stg}	storage temperature		-55 to 175	°C
Ti	junction temperature		175	°C



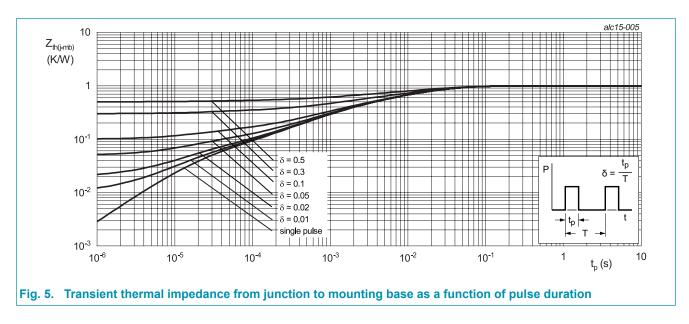
Ultrafast power diode

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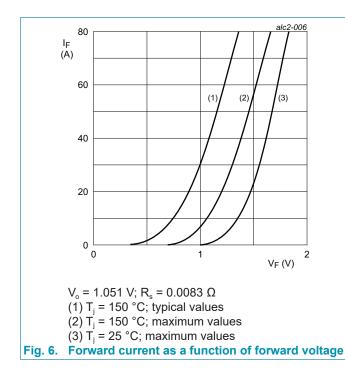
9. Thermal characteristics

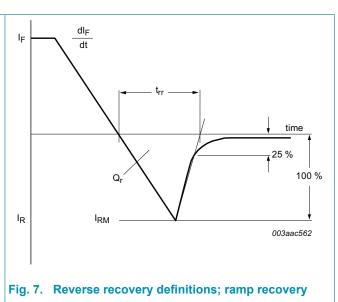
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	<u>Fig. 5</u>	-	-	1	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	45	-	K/W



10. Characteristics

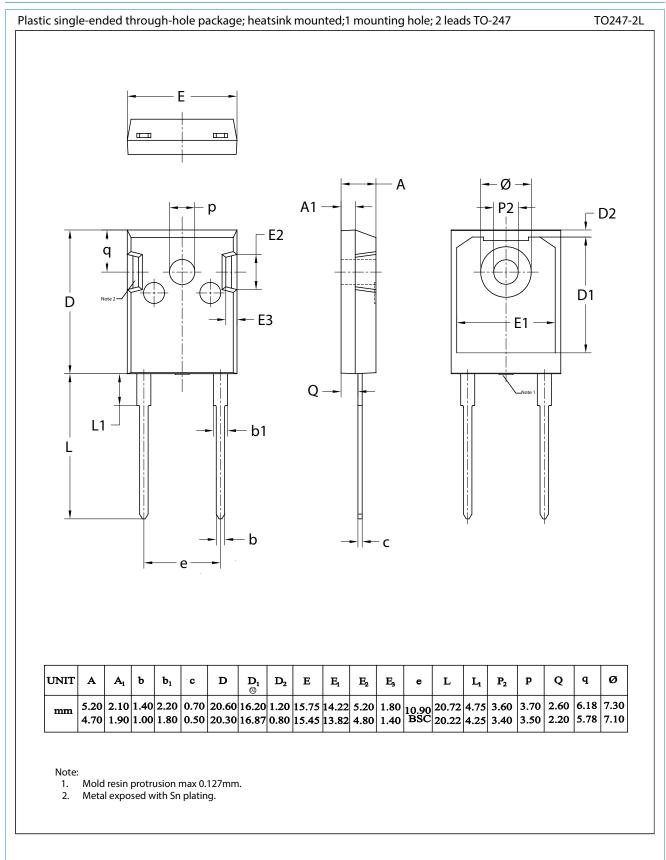
Table 7. Cl	haracteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
$V_{\rm F}$	forward current	I _F = 30 A; T _j = 25 °C; <u>Fig. 6</u>	-	1.18	1.55	V
		I _F = 30 A; T _j = 150 °C; <u>Fig. 6</u>	-	0.98	-	V
I _R	reverse current	V _R = 600 V; T _j = 25 °C	-	2	10	μA
		V _R = 600 V; T _j = 125 °C	-	-	500	μA
Dynamic	characteristics	· · · · ·	·			
Q _r	reverse charge	$ I_F = 30 \text{ A}; V_R = 400 \text{ V}; dI_F/\text{d}t = 200 \text{A}/\mu\text{s}; \\ T_j = 25 ^\circ\text{C}; \underline{\text{Fig. } 7} $	-	272	-	nC
		$ I_F = 30 \text{ A}; V_R = 400 \text{ V}; dI_F/\text{d}t = 200 \text{A}/\mu\text{s}; \\ T_j = 125 ^\circ\text{C}; \underline{\text{Fig. } 7} $	-	775	-	nC
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	42	75	ns
		$I_F = 30 \text{ A}; V_R = 400 \text{ V}; \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$	-	65	-	ns
		$I_F = 30 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$ $T_j = 125 \text{ °C}; Fig. 7$	-	101	-	ns
I _{RM}	peak reverse recovery current	$I_F = 30 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	8.4	-	A
		$I_F = 30 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$ $T_j = 125 \text{ °C}; Fig. 7$	-	15.2	-	А





BYV30W-600PT2 Ultrafast power diode

11. Package outline



BYV30W-600PT2 Product data sheet

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Ultrafast power diode

12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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BYV30W-600PT2

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